

IN THE CLAIMS:

Please cancel claims 1-13 without prejudice and add new claims 14-28 as follows:

14. (New) A method for surface treatment comprising the steps of:
cleaning a surface of an object to be processed using ClF₃ gas; and
removing chlorine derived from the ClF₃ gas still remaining on the surface of the
object to be processed after the step of cleaning the surface.
15. (New) A method for surface treatment comprising the steps of:
cleaning a surface of an object to be processed by using chlorine-containing gas;
and
removing chlorine derived from the chlorine-containing gas still remaining on the
surface of the object to be processed after the step of cleaning the surface.
16. (New) A method for surface treatment according to claim 14, wherein the
step of removing chlorine includes a step of removing chlorine from the surface of the
object to be processed by using a reducing gas.
17. (New) A method for surface treatment according to claim 16, wherein the
reducing gas is H₂ gas.
18. (New) A method for surface treatment comprising the steps of:
making ClF₃ gas adhere to a surface of an object to be processed by supplying
the ClF₃ gas to the surface of the object to be processed;
interrupting the supply of the ClF₃ gas to the surface of the object to be
processed; and

cleaning the surface of the object to be processed by using the ClF_3 gas
adhering to the surface of the object to be processed.

19. (New) A method for surface treatment comprising the steps of:
making cleaning gas adhere to a surface of an object to be processed by
supplying the cleaning gas to the surface of the object to be processed;
interrupting the supply of the cleaning gas to the surface of the object to be
processed; and
cleaning the surface of the object to be processed by using the cleaning gas
adhering to the surface of the object to be processed.
20. (New) A method for surface treatment according to claim 18, wherein the
object to be processed is cooled to 20° C or below in the step of adhering to the object.
21. (New) An apparatus for surface treatment comprising:
a processing vessel in which an object to be processed is placed;
a means for supplying ClF_3 gas into the processing vessel;
a means for activating the ClF_3 gas supplied in the processing vessel; and
a means for supplying a reducing gas into the processing vessel.
22. (New) An apparatus for surface treatment comprising:
a processing vessel in which an object to be processed is placed;
a means for supplying ClF_3 gas into the processing vessel;
a means for promoting adhesion of ClF_3 gas to the object to be processed; and
a means for activating ClF_3 gas supplied in the processing vessel.

*Sink
fb
Cvntd
A 2*

23. (New) An apparatus for surface treatment according to claim 22, further comprising a mount located in the processing vessel to set the object to be processed thereon.

24. (New) An apparatus for surface treatment according to claim 23, wherein the means for promoting adhesion of the ClF₃ gas to the object to be processed is provided in the mount to function to cool the object to be processed on the mount.

25. (New) An apparatus for surface treatment according to claim 24, wherein the means for activating the ClF₃ gas heats the object to be processed in a heating position distant from the object setting position for setting the object on the mount.

26. (New) An apparatus for surface treatment according to claim 25, further comprising a means for elevating and lowering the object to be processed between the object setting position and the heating position.

27. (New) A cluster device comprising:
the apparatus for surface treatment according to claim 21, wherein a transport chamber capable of maintaining a non-reactive atmosphere inside and capable of transporting an object to be processed in the non-reactive atmosphere to and from the surface processing apparatus; and

on or more processing apparatuses capable of transporting the object to be processed to and from the transport chamber.

28. (New) The cluster device according to claim 27, wherein the apparatus for surface treatment is a metal wiring formation chamber for making metal wiring on the object to be processed.